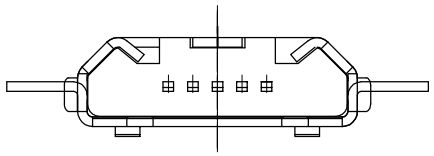
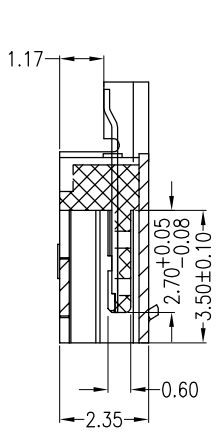
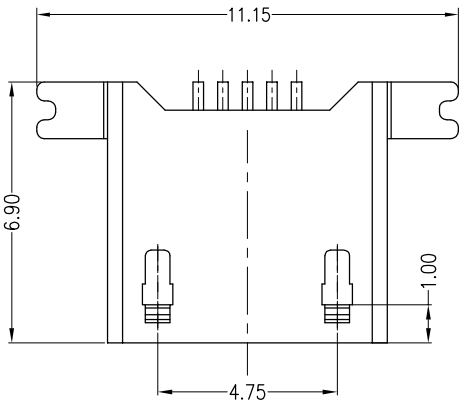
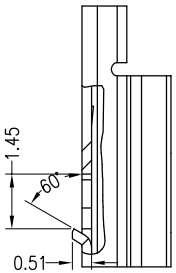
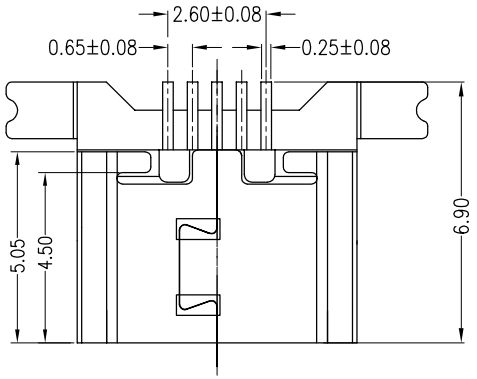
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE

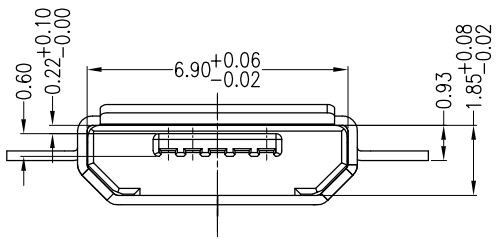


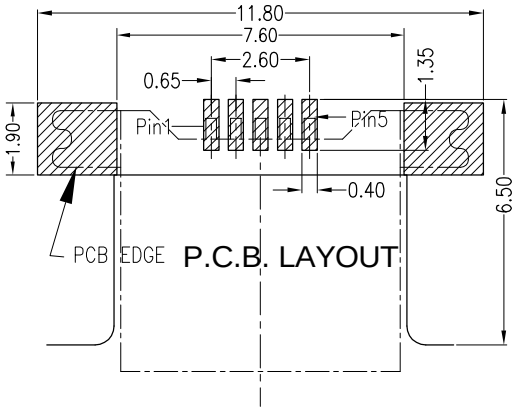












Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

RECOMMANDED PCB LAYOUT

PCB图仅供参考

外壳材质
1:C260R-H

外壳电镀
1:N50u''
2:雾T50u''
3:N+Au1u'' (脚)
4:Au1u''

端子电镀 01:Au1u'';02:Au1.5u'';03:Au3u''
05:Au5u'' ;10:Au10u'';15:Au15u'';30:Au30u''

主体颜色 B:黑色

主体材质 1:LCP

端子材质 4:C5191R-EH

PART NO: USB-F06505-CB056		MATERAL: SEE NOTE	深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD
MODEL NO: XX		FINSH: SEE NOTE	WFDCONN
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro usb 5s B Type Smt(破板式)两只脚贴板式无导位
TOLERANCE UNSPECIFIED .x 0.15 .xx 0.10 .xxx 0.05 Ang. 1°		DR: LIU MIAO	DWG NO: A052 REV: A
		CHK: SIMON	
		APP: DAVID	SCALE: 5:1 DATE: 2012.05.22